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# **FAIRCHILD**

## FDC2612 200V N-Channel PowerTrench<sup>®</sup> MOSFET

## **General Description**

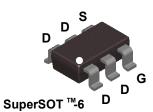
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $R_{DS(ON)}$  and fast switching speed.

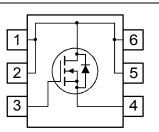
## Applications

DC/DC converter

## Features

- 1.1 A, 200 V.  $R_{DS(ON)}$  = 725 m $\Omega$  @ V<sub>GS</sub> = 10 V
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Fast switching speed
- Low gate charge (8nC typical)





## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source	e Voltage		200	V
V <sub>GSS</sub>	Gate-Sourc	e Voltage		± 20	V
ID	Drain Current – Continuous (Note 1a)			1.1	
	– Pulsed			4	
PD	Maximum Power Dissipation (Note 1a)		(Note 1a)	1.6	W
			(Note 1b)	0.8	
			()	010	
		nd Storage Junction T	· · ·	-55 to +150	°C
Therma	al Charac	Ū	emperature Range		°C °C/W
T <sub>J</sub> , T <sub>STG</sub> <b>Therma</b> R <sub>0JA</sub> R <sub>0JC</sub>	al Charac Thermal Re	teristics	emperature Range	-55 to +150	
Therma <sub>Rөја</sub> Rөјс Packag	al Charac Thermal Re Thermal Re	teristics	Ambient (Note 1a) Case (Note 1)	-55 to +150 78	°C/W

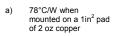
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FDC2612 Rev B3 (W)

FDC2612

Electrical Characteristics T <sub>A</sub> = 25°C unless otherwise noted						1
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics	·				
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	200			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		246		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSSF</sub>	Gate–Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}$ , $V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2	4	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		-8.7		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On Resistance			605 1133	725 1430	mΩ
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS}$ = 10 V, $V_{DS}$ = 10 V	4			A
<b>g</b> fs	Forward Transconductance	$V_{DS} = 10 V$ , $I_D = 1.1 A$		4.4		S
Dynami	c Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 100 V$ , $V_{GS} = 0 V$ ,		234		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		18		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			8		pF
Switchi	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	V <sub>DD</sub> = 100 V, I <sub>D</sub> = 1 A,		6	12	ns
tr	Turn–On Rise Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		6	12	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			17	30	ns
t <sub>f</sub>	Turn–Off Fall Time			8	16	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 100 V, I <sub>D</sub> = 1.1 A,		8	11	nC
Q <sub>gs</sub>	Gate–Source Charge	V <sub>GS</sub> = 10 V		1.6		nC
$Q_{gd}$	Gate–Drain Charge			2.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				1.3	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_{S} = 1.3 A$ (Note 2)		0.8	1.2	V
rr	Diode Reverse Recovery Time	$I_{\rm F} = 1.1 {\rm A},$		74.5		nS
Q <sub>rr</sub> lotes:	Diode Reverse Recovery Charge	$d_{iF}/d_t = 300 \text{ A}/\mu \text{s}$ (Note 2)		194		nC





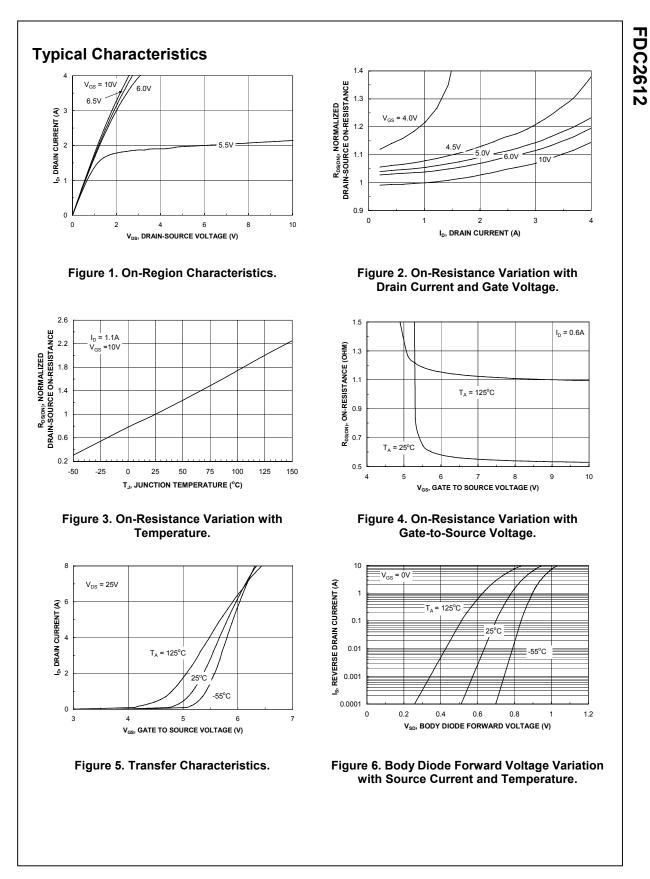


b) 156°C/W when mounted on a minimum pad of 2 oz copper

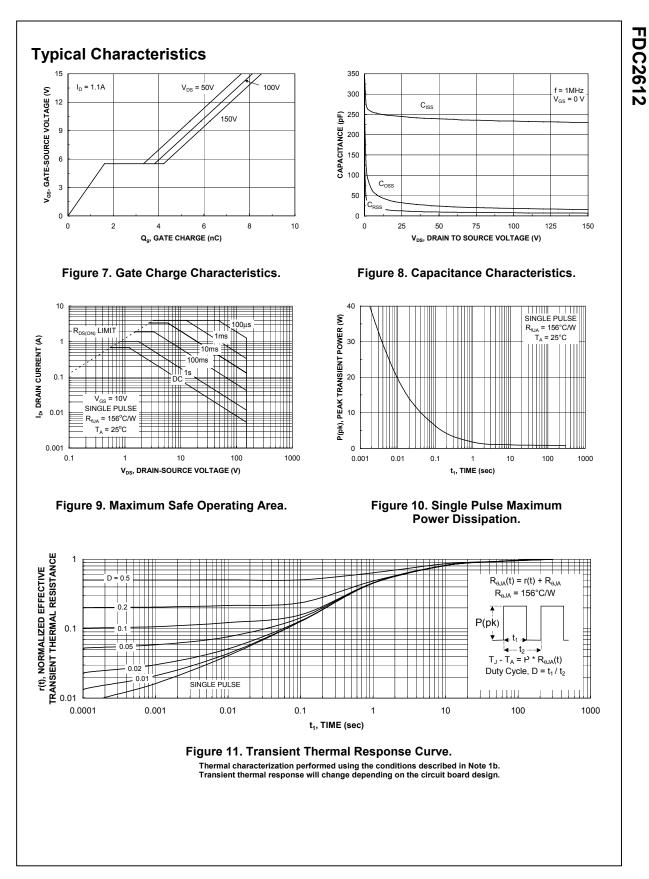
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

FDC2612 Rev B3(W)



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